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What is claimed is:

- 1. A wire bonding capillary for pressing a metal wire against an electrode pad comprising a capillary tip having a pressing face, wherein at least a part of the pressing face of the capillary tip is coated with a layer of polymeric material, said polymeric material including at least one thermoplastic polymer.
- 2. The wire bonding capillary as in claim 1 wherein said thermoplastic polymer is poly-p-xylylene.
 - 3. A method for preparing a wire bonding capillary comprising the steps of:
 - (a) providing a wire bonding capillary for pressing a metal wire against an electrode pad comprising a capillary tip having a pressing face; and,
 - (b) coating at least part of said pressing face of said capillary tip with a layer of polymeric material, said polymeric material including at least one thermoplastic polymer.
- 4. The method as in claim 5 wherein said thermoplastic polymer is poly-p-xylylene.

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